EEMI450 and global 450mm Cooperation

Bas van Nooten

- Spokesman EEMI450
- Semi Consulting on behalf of ASM International

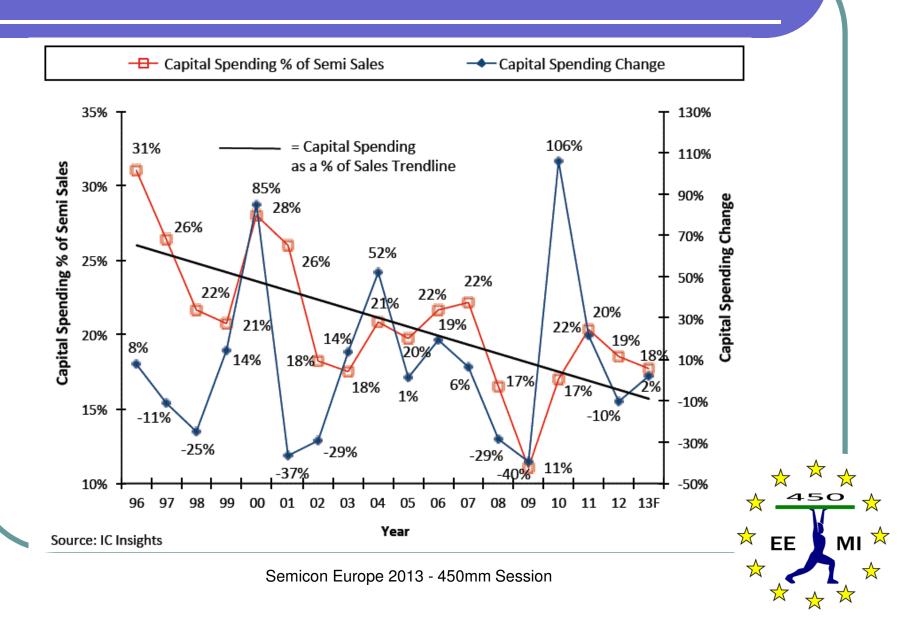


Overview

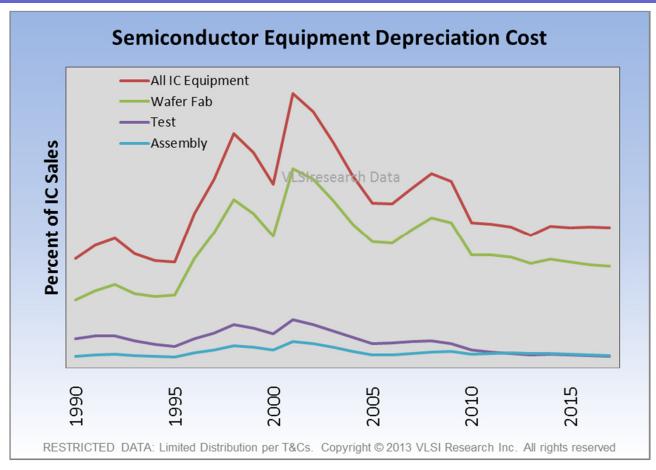
- Semi-equipment market
- 450mm R&D
- 450mm E&M activities in Europe
- International Collaboration



Semi equipment costs per sq./cm



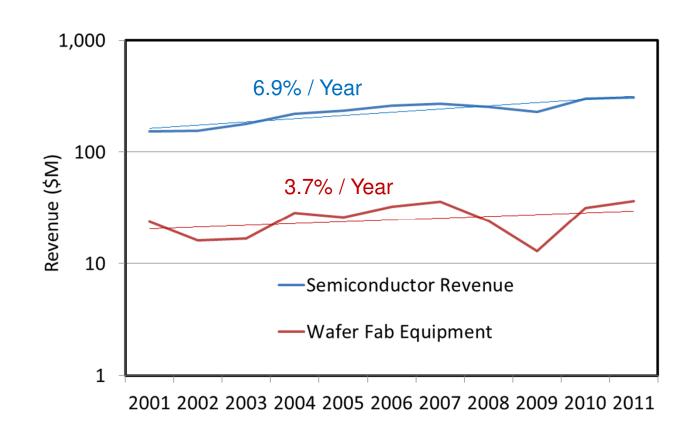
Equipment depreciation costs



Source: VLSIresearch. Chart approved for public release with attribution. Copyright © 2013 VLSI Research Inc. All rights reserved.



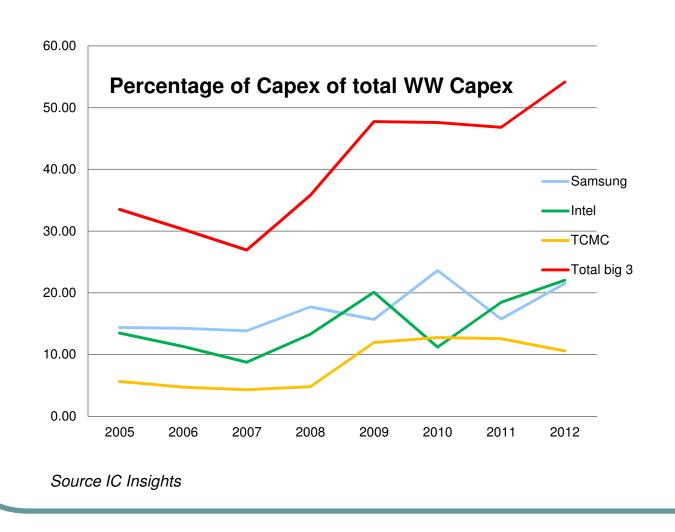
Revenue diverging



Source: VLSI/SEMI

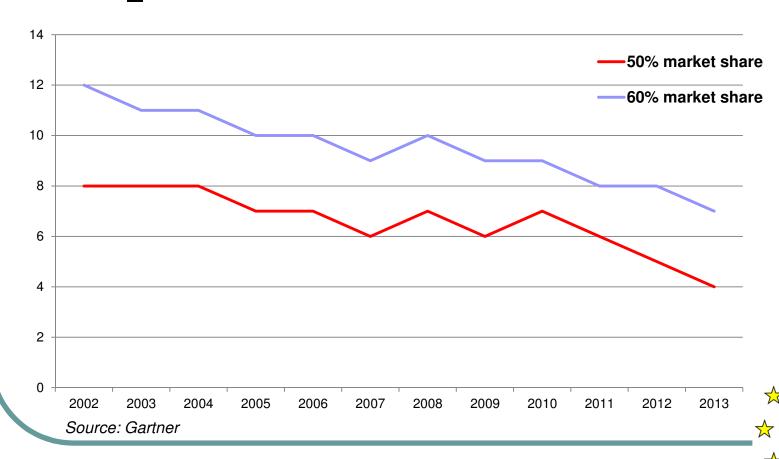


Consolidation customers



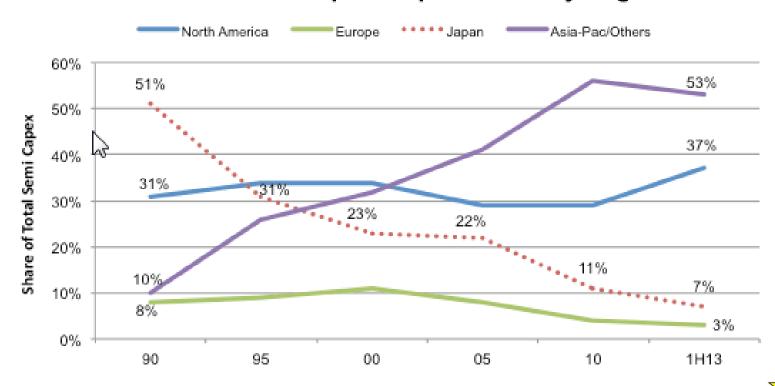
Consolidation Equipment suppliers

Number of equipment suppliers providing cumulative market share of $\geq 50/60\%$ of total market



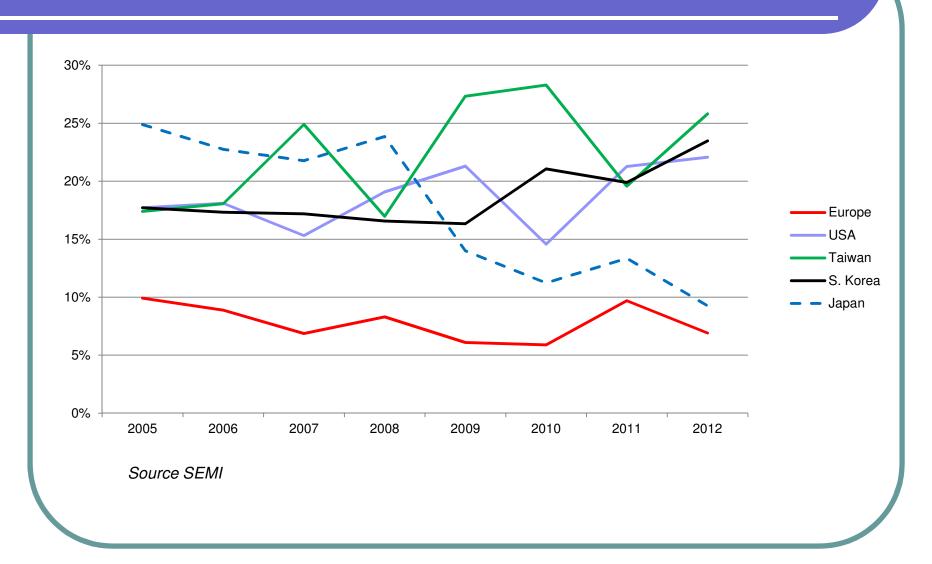
Equipment market per region

Semiconductor Capital Expenditures by Region



Source: IC Insights

Equipment market % per region



Foundries capital spending

Major Pure-Play Foundries' Capital Spending as a Percent of Sales Trends

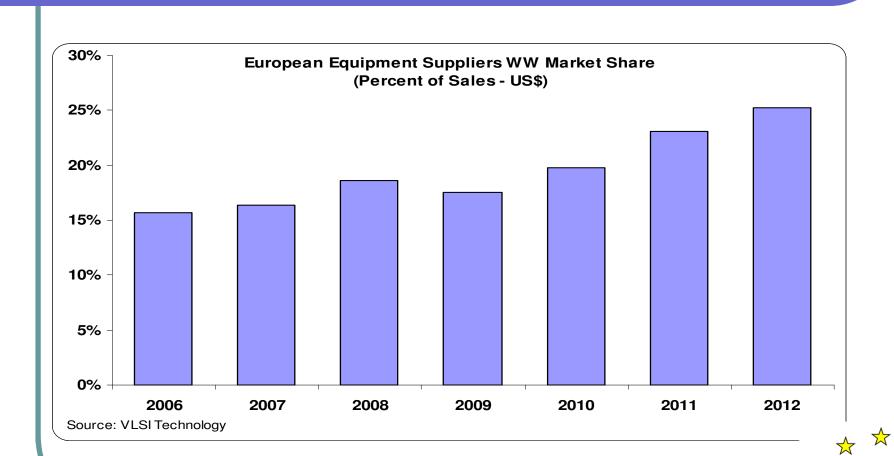
Company	2000	2005	2006	2007	2008	2009	2010	2011	2012	2013F
тѕмс	94%	28%	25%	26%	18%	30%	45%	51%	49%	50%
UMC	76%	21%	27%	25%	11%	20%	47%	48%	47%	38%
GlobalFoundries*	N/A	N/A	N/A	N/A	N/A	42%	78%	155%	83%	88%
SMIC	N/A	77%	61%	55%	49%	18%	47%	58%	32%	30%
Chartered	85%	55%	36%	52%	33%	26%	N/A	N/A	N/A	N/A
Total	86%	33%	30%	31%	21%	27%	50%	67%	54%	53%
Semiconductor Industry Average	28%	20%	22%	22%	16%	11%	17%	21%	19%	18%
Percentage of "Final Sales"**	39%	15%	14%	14%	9%	12%	23%	30%	24%	24%

^{*}Includes Chartered beginning in 2010.

Source: IC Insights

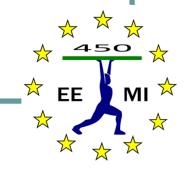
^{**}Assumes a 55% gross margin for the foundries' customers.

EU based equip. suppliers



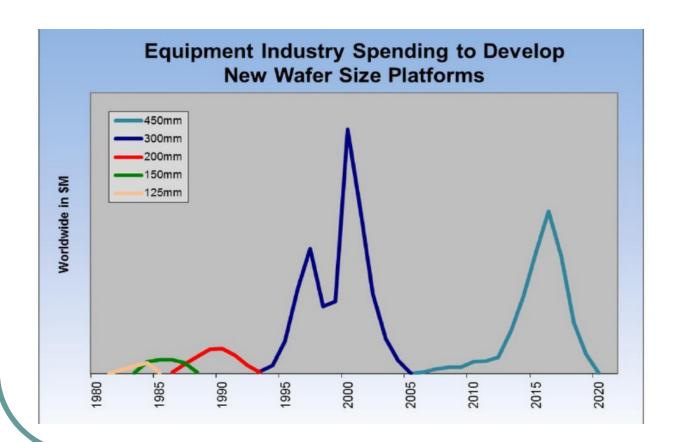
Overview

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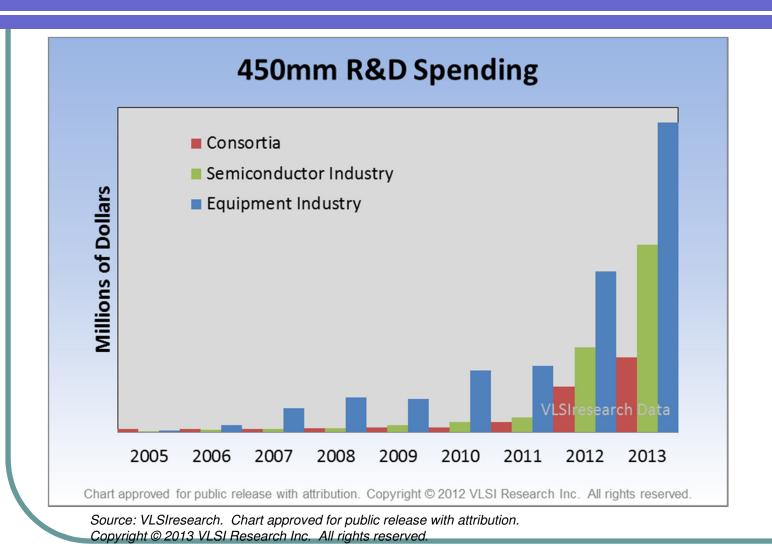
Forecasted 450mm investements

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450mm R&D Spending



Overview

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European Cooperation

Membership of EEMI450

Started in 2009 20 members

2010 (start project) 32 members

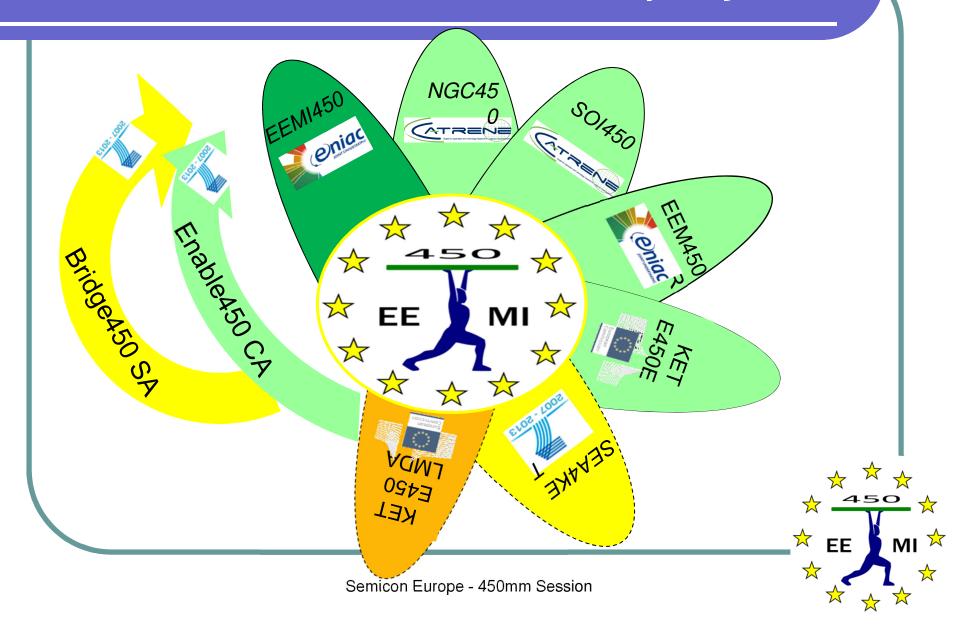
2011 40

2012 46

201354 members



EEMI450 related projects



EEMI450 related projects

- The EEMI450 community has initiated 8 European 450mm projects, which were granted up to now:
 - EEMI450 (ENIAC) 2010 2012
 - NGC450 (Catrene), started end of 2011 till end off 2014
 - SOI450 (Catrene), started end of 2011 till 2014
 - EEM450PR (ENIAC), started in April 2012 till April 2015
 - Enable450 (FP7 CA), started end of 2012 till end of 2015
 - E450EDL (ENIAC KET- Demo line), just started, duration 3 years
 - SEA4KET (FP7, partly 450mm), will start shortly, duration 3 years
 - Bridge450 (FP7 CSA), will start shortly, duration 2 years



More projects

- Recently a large ENIAC KET- pilotline proposal was submitted: E450LMDAP (European 450mm Lithography and Metrology Development for Advanced Patterning)
- This is a very large litho centric proposal, coordinated by ASML.
- Further project proposals to be submitted in 2014 are expected.
- All current ENIAC projects are containing equipment evaluations at imec, especially E450EDL (Equipmentdemo-line) and E450LMDAP are targeting a European 450mm demo/pilotline at imec.

Overview

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Enable450/EEMI450

- Within the Enable450 project, a so-called Coordination Action funded by the EU, international collaboration was one of the tasks defined.
- During the first year of the project several discussions with G450C, both face-to-face (Brussels and Albany), as by conf. calls, took place to exchange information and establish common cooperation topics.
- In addition on the Taiwan-EU ICT Technical Cooperation Conference in March 2013, several 450mm presentations were given by EEMI450 members.

- Common protocol for tool assessment and alignment on DTS (Demonstration Test Method)
 - Advantage for equipment suppliers:
 Tools can be evaluated at either imec of G450C and results are transparent
 - Common approach discussions ongoing
 - Opens possible coordination between imec and G450C, where equipment could be assessed

Metrology

- Overview what is available on both sides of the ocean was shared.
- Especially in the early phase where not all equipment is available everywhere a "global" lab would be advantageous
- Cooperation between G450C and Metro450 under discussion
- Calibration wafer standard on the agenda



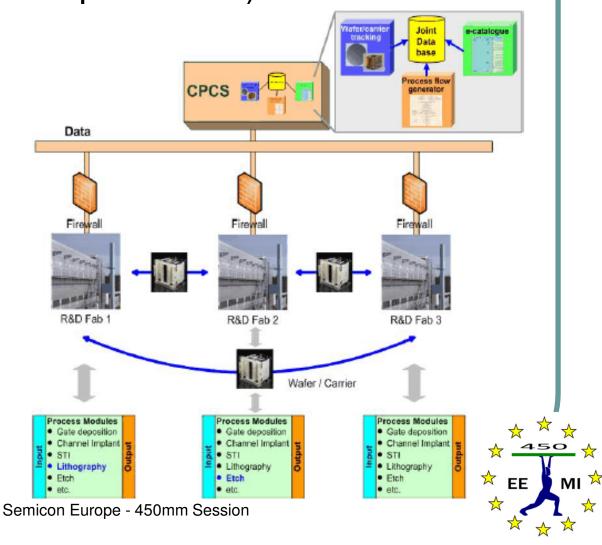
- AMC (Airborne Molecular Contamination)
 - Topics of Collaboration as proposed by FhG IISB:
 - Minienvironment evaluation by sampling and offline analysis
 - Passive sampling using sorbent tubes
 - Active sampling by impinger (requires qualified staff @ sampling site)
 - Investigation and evaluation of different decontamination strategies
 - Set-up of different contamination/decontamination scenarios for wafers, FOUPs/MACs and other minienvironments
 - Monitor and optimize decontamination efficiency
 - Definition of AMC limits (in close cooperation with manufacturing sites)
 - Identify critical parameters from processes/equipment/in situ sensors/... to predict the amount of contamination and the right time for decontamination (APC)
 - End-of-life prediction for FOUPs/MACs

- 450mm (test)wafers
 - European partners, coordinated by imec, are sending their requirements concerning
 - Quality, numbers and timing to G450C, which will include those in their total 450mm wafer orders
- Advantages
 - Pricing
 - Consistent quality both sides of the ocean.

Flying wafer (concept 300mm)

- Wafers are exchanged between R&D sites for processing and characterisation
- Wafers are transferred using predefined I/O procedures
- Wafer controlled using defined specifications for contamination level and control methods
- Process/metrology and logistic data is transferred to and made accessible by a Central Planning and Control System (CPCS)

Source FhG IISB



Flying wafer for 450mm

Objective

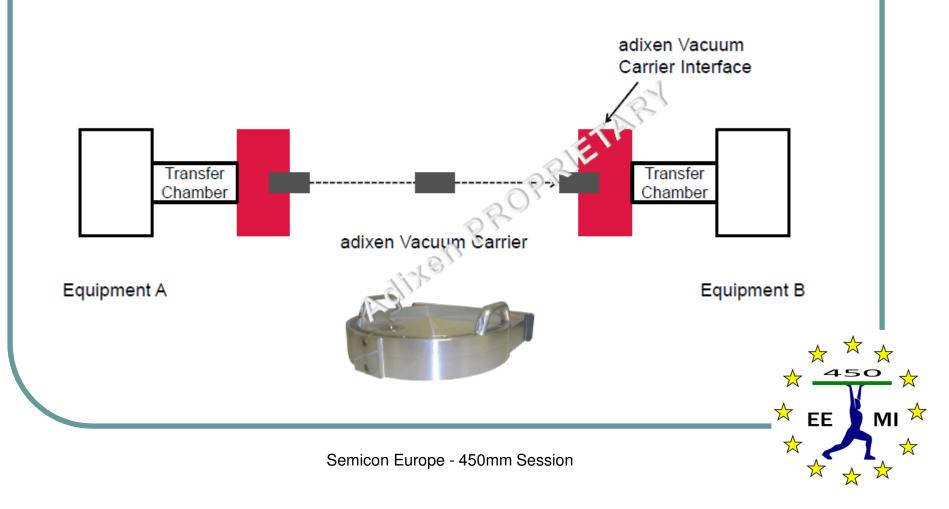
To develop a gradual concept for the implementation of a flying wafer infrastructure for 450 mm, building on the process resources at 450 mm sites, R&D sites, equipment suppliers to accelerate collaboration and learning curve

Proposed activities

Exhaustive specifications of a flying wafer infrastructure with different grades of implementation levels, e.g. base level (e.g. for equipment supplier) with wafer specifications. High end level (manufacturing site) includes full set of specifications.

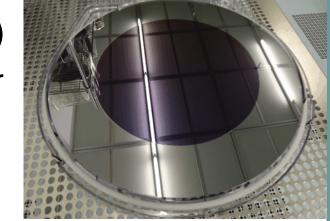
A kind of "Flying Wafer™" certificate might be elaborated; Fraunhofer IISB might act as certification entity providing the required expertise and control methods and services, respectively.

Flying wafer wafertransport carrier



- 450mm Pocket wafer (Xycarb)
 - A common 450mm pocket wafer
 - To be able to measure smaller wafers in a 450mm environment

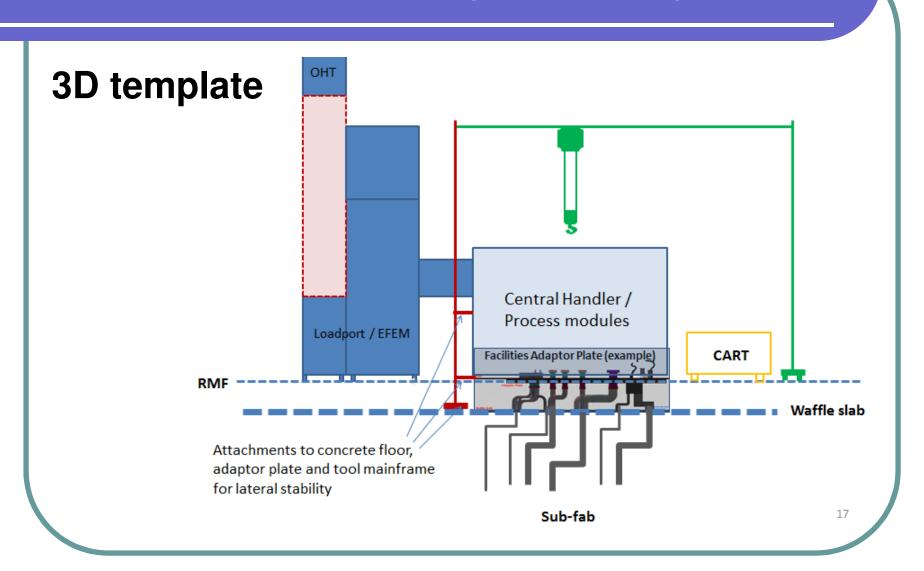
is under discussion as well



- Green idle mode
 - Green idle mode of vacuum equipment, under development in the EEM450PR project, is on the common agenda as well. Standards are being developed, but process implications have to be investigated.

• F450C

- The Facilities 450mm Consortium (F450C) is a first-of-its-kind partnership at SUNY's College of Nanoscale Science and Engineering (CNSE) that is leading the global effort to design and build next-generation 450mm computer chip fabrication facilities. The collaboration includes 10 of the world's leading nanoelectronics facility companies, including Air Liquide, CH2M HILL, CS Clean Systems, Ceres Technologies, Edwards, Haws Corporation, Mega Fluid Systems, M&W Group, Ovivo and Swagelock.
- One of the objectives is to come to standard facilities 3D template for installation to ease the effort and reduce installation time when the system is brought into the cleanroom.



- SEA4KET (FP7) project
 - In this European project a vertical furnace will be evaluated at G450C
 - Data obtained at G450C may be used in the project



EU-Taiwan (Asia) cooperation

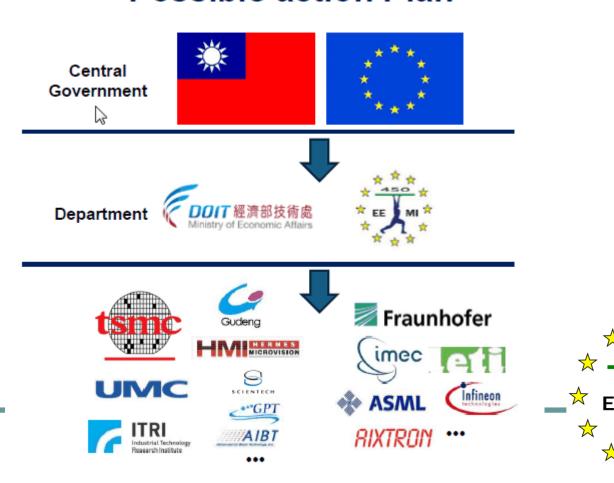
- In the Brige450 FP7 "Support Action" project, which can be viewed as an extension of Enable450, the emphasis is put on intensifying contacts with Asia and visits are planned to the tier 1 semi companies.
- Example: the mentioned EU-Taiwan conference where 450mm related EU Taiwan cooperation was discussed, especially since Taiwanese institutes and companies now may join EU projects.

Taiwanese ideas

2 heads are better than 1

- Co-exploring the emerging opportunity on 450mm-

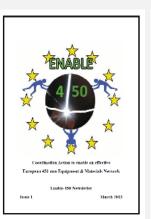
Possible action Plan



Enable450 newsletter

- Within the Enable450 project a Newsletter is generated, distributed and published on the project website: www.enable450.eu
- This newsletter provided by Future Horizons gathers global 450mm related information and is available to the global community

March 2013



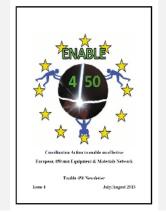
April 2013



May & June 2013



July & Aug. 2013





Semicon Europe - 450mm Session

Thank you

Thank you for your attention!

